



POST-EVENT REPORT

Innovative Materials and Technologies in Home Appliance & 3C Industry Summit 2018

August 29th - 30th | The Longemont Shanghai



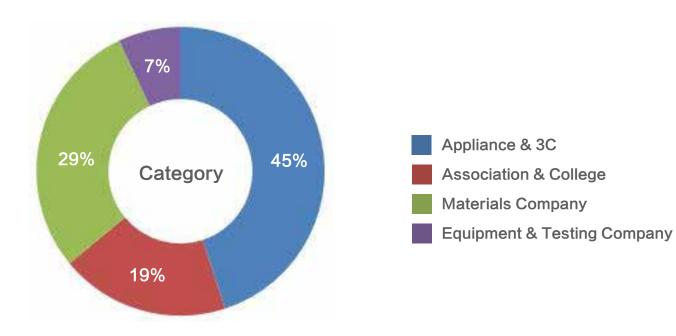
会议背景:

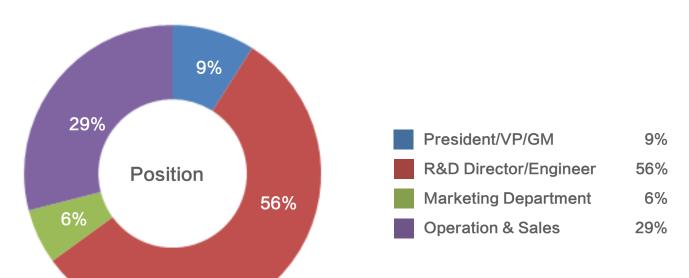
The related industry always has huge progress with the breakthrough of materials and technologies. The younger generation of consumers become the major power of home appliance and 3C products, whose consumption habits and consumption patterns will lead the change of home appliance and 3C industry. How to design the products, How to choose materials, and how to apply the technologies are the questions the should be considered by every practitioner.

Under this background, "Innovative Materials and Technologies in Home Appliance & 3C Industry Summit 2018" has been held in Shanghai on August 29th – 30th, which will invite experts coming from appliance & 3C OEMs, associations & colleges and materials & technologies suppliers, to discuss the industry trend, design idea, breakthrough of materials & technologies, and so on. Cling to the industry pulse and look for real business opportunities.

150+ experts, 15 keynote speech, 10+ spot interviews. More than 150 professional attendees, from SHEAPA, CHEARI, Midea Group, Hisense Group, Chunmi, Panasonic, LENOVO, Gree Group, HP China, ZTE, ASUS, AUX Group, Hi-p Group, Dell, Samsung, Wing Tech, are gathered together.







Speech



Ms. Vivian SHANG
General Manager, East China
Shanghai Ringier Conference &
Exhibition Co.,Ltd
Opening Address



Mr. Fuchun LI
General Secretary
Shanghai Household Electric Appliance
Profession Association
Opening Address

45%

19%

29%

7%

Speech



Mr. Zhongmin SUN
Director of Expert Committee
Shanghai Household Electric Appliance
Profession Association

Topic: Transition of China Household Appliance Manufacturing Industry



Mr. Tian CHU
Product Manager
Shanghai Chunmi Electronic technology
Co.,Ltd (A Xiaomi Branch)

Topic: Trend Analysis of Intelligent Product Design and CMF



Mr. Liyi SHI
General Manager, Director

Shanghai University National Science Park Shanghai New Materials and Application Innovation Center

Topic: Application of Innovative Materials in Green Home Appliances

Mr. Jason ZHENG



Technology Development Manager Covestro Polycarbonate Division

Topic: Solutions of Polycarbonate for Home Appliances Design and Intelligent Application



Mr. Aimin ZHANG

Director

Polymer Synthesis Theory and Technology Research Institute, Polymer Research Institute of Sichuan University Topic: Application of Thermoplastic

Elastomers in Household Appliances



Mr. Mark LIN

Director of the Special Plastic Material Committee

Association of CAE Molding Technology Topic: Development and Application of Interior and Extra-membrane Decoration Technology



Mr. Fei WU

Senior Engineer
Ningbo Institute of Industrial Technology, CAS
Topic: Preparation and Application of

Polypropylene Foamed Materials



Mr. Wenjun ZHANG

CMF Designer Hisense Group

Topic: The Change of Color and Materials from the Angle of CMF Design



Mr. Yanxin CAO

Materials Analysis Director China Household Electric Appliance Research Institute

Topic: Consistency Control of Non-metallic Materials for Household Appliances



Mr. Zhichao ZHEN

Senior Engineer

Technical Institute of Physics and Chemistry, CAS

Topic: Application of Antimicrobial and Anti-mildew Materials in Household Appliances



Mr. Wangchun FEI

Research Engineer Kitchen and Hot Water Business Department of Midea Group

Topic: Research on Antibacterial and Mildew Prevention Technology of Dishwasher Products



Ms. Keran WANG

Technical Supervisor EET RSTS, China

Topic: Attention to the Comprehensiveness of New Materials R&D



Mr. Wen YE

Deputy Director of Functional Materials Shanghai Research Institute of Chemical Industry

Topic: Halogen Free Flame Retardant Solution for Polymer Materials



Mr. Chao HUANG

Development Director

Panasonic R&D Center (Hangzhou) Co., Ltd Topic: Developing and Development of

"nanoe X" Generating Device for Charged

Micro Particle Water

Feedback

Thank Ringier for providing such a platform for us to learn and explore new technologies, processes and trends in the material industry. I hope we can find some suppliers of new materials.

— ZTE Senior Designer

The topics are very good, thanks to the organizer. The topics can be more extensive, such as steel, appearance treatment, etc.

— ASUS Senior Engieer

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Conferenc Scene









部分参会企业

SHEAPA Juner China

Hisense Group Gree Group

Shanghai Chunmi Electronic technology Co.,Ltd TRUMPGROUP

China Household Electric Appliance Research Du Pont Apollo (Shenzhen) Limited

Institute Zhejiang Java Specialty Chemicals Co.,Ltd

Shanghai University National Science Park Kurz Hefei

Shanghai New Materials and Application Innova-PHARADH

tion Center HP

Technical Institute of Physics and Chemistry, CAS Nanjing Huage

Kitchen and Hot Water Business Department of Micoe Group

Midea ZTE

Polymer Research Institute of Sichuan University ASUS

Shanghai Research Institute of Chemical Industry

Sassin International Electric Shanghai Co., Ltd

Ningbo Institute of Industrial Technology, CAS AUX Group

Panasonic R&D Center (Hangzhou) Co., Ltd Hi-p Group

Association of CAE Molding Technology PHICOMM

Covestro Polycarbonate Division Yili China

EET RSTS, China Shanghai Chunmi Electronic technology Co.,Ltd

EMS-CHEMIE (Suzhou) Ltd. LEXY Group

OECHSLER Plastic Products (Taicang) CO., LTD. Kuaishou Axiu

Dongguan Liyi Test Equipment Co., LTD Dell Technology

FCS Group Wingtech Communications

Shanghai Sunny Technology Co., Ltd. TRANSSION Holdings

BYK-Gardner GmbH Shanghai Homwee

Suzhou Kingchem Plastic Technology Co., Ltd Samsung

Kurz Hefei Aupu Group

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